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26 July 2016

TC-2

Meeting Announcement

Committee:	TC-2; Electromagnetic Compatibility (EMC) Measurements
Place:	The Shaw Centre Ottawa
Date:	26 July 2016 (Tuesday)
Time:	7:00 to 8:30 AM
Room:	203
	Continental breakfast available

AGENDA

- 1.0 Call to Order/Introductions
- 2.0 Approval of 2015 Minutes from IEEE EMC TC-2 meeting (18 August 2015) at Dresden.
- 3.0 Committee Membership Status
 - 3.1 Removal of non-active participants from membership roster.

Membership indicates that you have attended the TC-2 committee meeting at least two (2) or more times in the last four (4) years; candidates are shown as attending a single meeting on or after 2013 and no other. By committee rules, these candidates are not members of TC-2 unless they attend a second face-to-face symposium meeting within a four year period.

All attendees will initial the sign-in roster. After the Ottawa TC-2 meeting, those that have not attended a face-to-face TC-2 meeting since 2013 will no longer be a TC-2 member but will remain on the list for one additional year to receive meeting announcements. Those that have not attended a face-to-face TC-2 meeting since 2012 will be removed from the list.

(See the 2016 membership list which is also the meeting sign-in roster.)

- 4.0 Current Symposium Activity, July 2016
 - 4.1 Symposium paper review status (top paper, top TC-2 paper, Round 2 reviewing, etc).

5.0 Standards Sponsorship Support Review

http://www.emcs.org/standards/sdecom/Standards_Matrix.html

IEEE Standards that are in review process or need to be placed in review process. These EMCS standards are

139 (Measurement of RF for ISM equipment on user's premises)

187 (TV/FM spurious emissions)

299 (Shielding effectiveness of enclosures)

299.1 (Shielding effectiveness of enclosures with dimensions between 0.1 & 2m)

P370 (Characterization of PCB interfaces up to 50 GHz)

377 (Land mobile spurious)

473 (Site Survey) + work with ANSI C63 draft C63.24 (In-situ Immunity testing)

475 (Field disturbance sensors)

1128 (Absorber performance)

1140 (Near field LF emissions)

1302 (Gasket characterization)

1309 (Probes)

1560 (Filters in the range 100Hz to 10GHz)

1597 (Validation of Computational EM Computer Modeling and simulations)

1597.1 (Validation of computer modeling & simulation)

1642 (Intentional EMI)

1688 (Module testing)

P1848 (Risk Management)

1897 (Resolution of Power Line Gap Noise Reports)

Study groups on planar shielding effectiveness measurement, shielding of PCB, and shielding of forensic bags/pouches

6.0 iNARTE Exam Question Review Activity

7.0 Future Symposium Activity

- 7.1 Future topics for IEEE conferences in Washington, DC, on 4-12 August 2017
- 7.2 Technical Program Responsibilities and session chair reminders
- 7.3 Paper Review Deadlines for 8/2017 (Washington)
- 7.4 Paper reviewers
- 7.5 Need session chairs
- 7.6 New membership
- 7.7 New areas of interest

8.0 Set meeting and agenda for next meeting(s)

8.1. Washington, DC, August 2017

9.0 Adjournment